

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Y. MIZUNO, et al.
Application No.: 10/529,738
Filed: MARCH 30, 2005
For: RESIN COMPOSITION FOR PRINTED WIRING BOARD AND
VANISH, PREPREG AND METAL CLAD LAMINATED BOARD
USING THE SAME
Group: 1796
Examiner: Robert E. Sellers
Confirm. No.: 1963

**INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR 1.97 AND 1.98**

Mail Stop: AMEND – NO FEE

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

April 5, 2010

Sir:

Pursuant to Applicants' duty of disclosure, enclosed please find a copy of an Official Action dated January 5, 2010, from the Japanese Patent Office, in the counterpart Japanese patent application. Also enclosed is an English translation of this Official Action dated January 5, 2010. Further enclosed is a copy of JP 2000-319509, newly cited in the enclosed Official Action, and English abstract of this patent document. Further enclosed is a Form PTO/SB/08A, listing the enclosed documents.

The enclosed Official Action also cites JP 2001-339130 and JP 2002-309085, each of which were cited in the Information Disclosure Statement submitted March 30, 2005, upon originally filing the above-identified application, and in the International Search Report for International (PCT) Application No. PCT/JP2003/12399, filed September 29, 2003, of which the above-identified

application is a National Stage application filed under 35 USC 371; and JP 2001-339130, which corresponds to U.S. Patent No. 7,157,506, cited by the Examiner in the Office Action dated December 10, 2007, in the above-identified application.

This Information Disclosure Statement is being submitted in an application subsequent to a first Office Action on the merits therein, but in an application which is not under a pending Final rejection and in which no pending Notice of Allowance has been issued, and in which no pending Office Action closing prosecution on the merits has been issued. For satisfying requirements of 37 CFR 1.97(c), the following Statement is made under 37 CFR 1.97(e):

Each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

To the extent that the enclosed documents are not in English, it is respectfully submitted that requirements of 37 CFR 1.98(a)(3) are satisfied by the enclosed English translation of the enclosed Official Action, and/or by the English abstract of JP 2000-319509 (also enclosed).

In view of the foregoing, it is respectfully submitted that all applicable requirements of 37 CFR 1.97 and 1.98 have been satisfied, in connection with present submission of the enclosed documents. Consideration of the enclosed documents, upon further examination of the above-identified application, is respectfully requested.

Please charge any shortage of fees due in connection with the filing of this paper to the Deposit Account of Antonelli, Terry, Stout & Kraus, LLP, Deposit

Account No. 01-2135 (case No. 511.44961X00), or credit any excess fees paid to such Deposit Account.

Respectfully submitted,

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